

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4630722

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JIN TAE HONG	09/26/2017
HEE POM LEE	09/26/2017
YOUNG WAN HAM	09/28/2017
CHUN SIK KIM	09/26/2017
HEON SANG JUNG	09/26/2017
DAE HWAN KIM	09/26/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	CHUNGBUK NATIONAL UNIVERSITY INDUSTRY-ACADEMIC COOPERATION FOUNDATION
<b>Street Address:</b>	1, CHUNGDAE-RO, SEOWON-GU
<b>City:</b>	CHEONGJU-SI, CHUNGCHEONGBUK-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	28644
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15564850
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	bostonipdocketing@dlapiper.com
<b>Correspondent Name:</b>	JEFFREY S. CLARK
<b>Address Line 1:</b>	DLA PIPER, LLP (US)
<b>Address Line 2:</b>	33 ARCH STREET, 26FL
<b>Address Line 4:</b>	BOSTON, MASSACHUSETTS 02110
<b>ATTORNEY DOCKET NUMBER:</b>	DAR-006
<b>NAME OF SUBMITTER:</b>	JEFFREY S. CLARK
<b>SIGNATURE:</b>	/Jeffrey S. Clark/
<b>DATE SIGNED:</b>	10/06/2017

**Total Attachments: 6**

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**ASSIGNMENT**

WHEREAS, We, Jin Tae Hong, Hee Pom Lee, Young Wan Ham, Chun Sik Kim, Heon Sang Jung and Dae Hwan Kim (hereinafter "ASSIGNORS") have invented one or more inventions described in an application (or provisional application) for Letters Patent of the United States entitled:

**"PHARMACEUTICAL COMPOSITION FOR PREVENTING OR TREATING ARTHRITIS OR INFLAMMATORY DISEASE CONTAINING 2-METHOXY-4-(3-(4-METHOXYPHENYL)PROPYL-1-EN-1-YL)PHENOL AS ACTIVE INGREDIENT"**

and identified by

☒ Application No. 15/564,850 filed in the U.S. Patent and Trademark Office on October 6, 2017; and

WHEREAS, CHUNGBUK NATIONAL UNIVERSITY INDUSTRY-ACADEMIC COOPERATION FOUNDATION (hereinafter "ASSIGNEE"), having a usual place of business at 1, Chungdae-ro, Seowon-gu, Cheongju-si, Chungcheongbuk-do 28644, Republic of Korea, desires to acquire an interest therein, in accordance with agreements duly entered into with me;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS have sold, assigned and transferred and do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, at least as early as the filing date of said application, our entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to the invention(s) described in said application, together with our entire right, title and interest in and to said application, and such Letters Patent that may issue thereon and applications that claim priority thereto under United States law or international convention, and such Letters Patent that may issue thereon, including but not limited to non-U.S., international, non-provisional, continuation, divisional, reissue, reexamination, extension, and substitution applications of said application and such Letters Patent, and any right, title and interest ASSIGNORS may have in provisional applications to which said application claims priority; said invention(s), applications and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; ASSIGNORS hereby convey all of our rights arising under or pursuant to any and all United States laws and international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent, including but not limited to any cause(s) of action and damages accruing prior to this assignment. ASSIGNORS hereby acknowledge that this assignment, being of our entire right, title and interest in and to said invention(s), carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all Letters Patent to ASSIGNEE in its own name as assignee of our entire right, title and interest therein;

AND, ASSIGNORS hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention(s) to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of papers for filing of non-provisional, substitution, continuation, divisional, reissue, reexamination, and corresponding foreign and international patent applications;

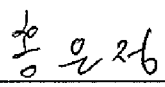
AND, ASSIGNORS hereby further agree to provide statements or testimony in any interference or other proceeding in which said invention(s) or any application or patent directed thereto may be involved;

AND, ASSIGNORS hereby authorize ASSIGNEE or its attorneys or agents to insert the correct serial number and filing date into this assignment, if none is indicated on the date of our execution of this assignment;

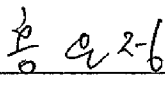
AND, ASSIGNORS do hereby authorize and request the Director of the United States Patent and Trademark Office and the empowered officials of all other governments to issue such Letters Patent as shall be granted upon said application, or applications based thereon, to said ASSIGNEE, its successors, assigns or legal representatives.

**IN TESTIMONY WHEREOF**, ASSIGNORS have hereunto set my hand and affixed my seal on the date set forth below.

Inventor   
Jin Tae Hong

Witness:  Date: Sep. 26, 2017

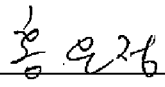
Inventor   
Hee Pom Lee

Witness:  Date: 09/26/2017

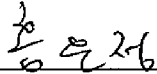
Inventor \_\_\_\_\_  
Young Wan Ham

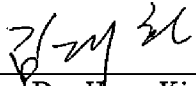
Witness: \_\_\_\_\_ Date: \_\_\_\_\_

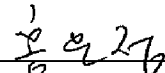
Inventor   
Chan Sik Kim

Witness:  Date: Sep. 26, 2017

Inventor   
Heon Sang Jung

Witness:  Date: Sep. 26. 2017

Inventor   
Dae Hwan Kim

Witness:  Date: Sep 26 2017

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AND, ASSIGNORS hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention(s) to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of papers for filing of non-provisional, substitution, continuation, divisional, reissue, reexamination, and corresponding foreign and international patent applications;

AND, ASSIGNORS hereby further agree to provide statements or testimony in any interference or other proceeding in which said invention(s) or any application or patent directed thereto may be involved;

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AND, ASSIGNORS do hereby authorize and request the Director of the United States Patent and Trademark Office and the empowered officials of all other governments to issue such Letters Patent as shall be granted upon said application, or applications based thereon, to said ASSIGNEE, its successors, assigns or legal representatives.

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Inventor \_\_\_\_\_  
Jin Tae Hong

Witness: \_\_\_\_\_ Date: \_\_\_\_\_

Inventor \_\_\_\_\_  
Hee Pom Lee

Witness: \_\_\_\_\_ Date: \_\_\_\_\_

Inventor \_\_\_\_\_  
Young Wan Ham

Witness:  Date: 9/28/97

Inventor \_\_\_\_\_  
Chun Sik Kim

Witness: \_\_\_\_\_ Date: \_\_\_\_\_

Inventor \_\_\_\_\_  
Heon Sang Jung

Witness: \_\_\_\_\_ Date: \_\_\_\_\_

Inventor \_\_\_\_\_  
Dae Hwan Kim

Witness: \_\_\_\_\_ Date: \_\_\_\_\_